

ZERO RECOVERY™ RECTIFIER

Features

- 600 Volt Schottky Rectifier
- Zero Reverse Recovery
- Zero Forward Recovery
- High Frequency Operation
- Temperature Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F

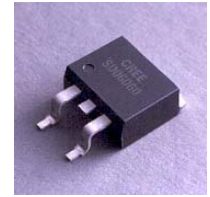
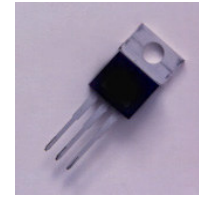
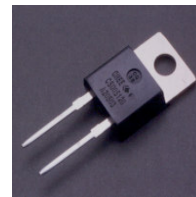
Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction Of Heat Sink Requirements
- Parallel Devices without Thermal Runaway

Applications

- Switch Mode Power Supplies
- Power Factor Correction
- Motor Drives

Package



CSD06060A

CSD06060B

CSD06060G

Maximum Ratings

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	600	V
Surge Peak Reverse Voltage	V_{RSM}	600	V
DC Blocking Voltage	V_{DC}	600	V
Average Forward Current $T_C=150^\circ\text{C}$	$I_{F(AV)}$	6	A
Repetitive Peak Forward Surge Current $T_C=25^\circ\text{C}$, $t_P=8.3\text{ms}$, Half Sine Wave	I_{FRM}	30	A
Non-Repetitive Peak Forward Surge Current $T_C=25^\circ\text{C}$, $t_P=10\mu\text{s}$, Half Sine Pulse	I_{FSM}	210	A
Power Dissipation $T_C = 25^\circ\text{C}$	P_{tot}	83.3	W
Operating Junction and Storage Temperature	T_J, T_{stg}	-55 to +175	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Typ	Max	Units
Forward Voltage $I_F = 6A$ $T_J = 25^\circ C$ $I_F = 6A$ $T_J = 175^\circ C$	V_F		1.6 1.9	1.8 2.4	V
Reverse Current $V_R = 600V$ $T_J = 25^\circ C$ $V_R = 600V$ $T_J = 175^\circ C$	I_R		50 100	200 1000	μA
Total Capacitive Charge $V_R = 600V, I_F = 6A, di/dt = 500 A/\mu s, T_J = 25^\circ C$	Q_C		17		nC
Total Capacitance $V_R = 0V, T_J = 25^\circ C, f = 1MHz$ $V_R = 200V, T_J = 25^\circ C, f = 1MHz$ $V_R = 400V, T_J = 25^\circ C, f = 1MHz$	C		340 40 30		pF

NOTE:

1. This is a majority carrier diode, so there is no reverse recovery charge.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Units
Thermal Resistance from Junction to Case	$R_{\theta JC}$		1.8		$^\circ C/W$

Typical Performance

Figure 1. Forward Characteristics

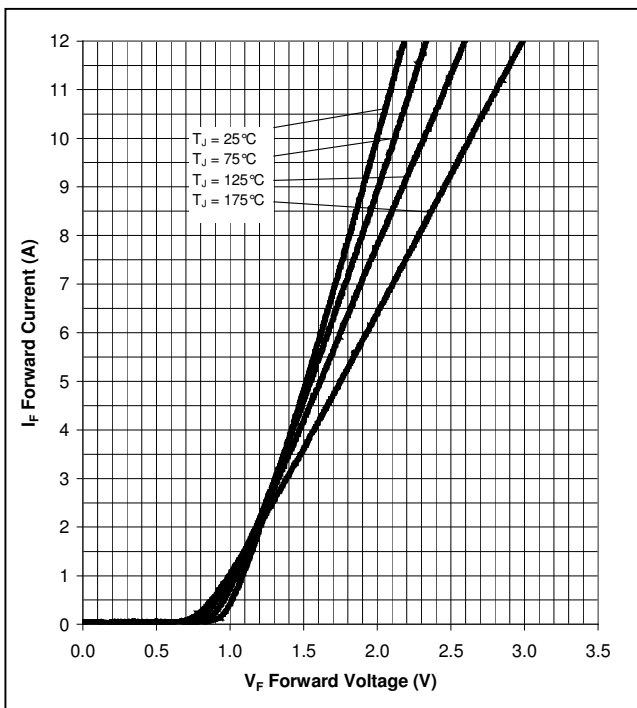


Figure 2. Reverse Characteristics

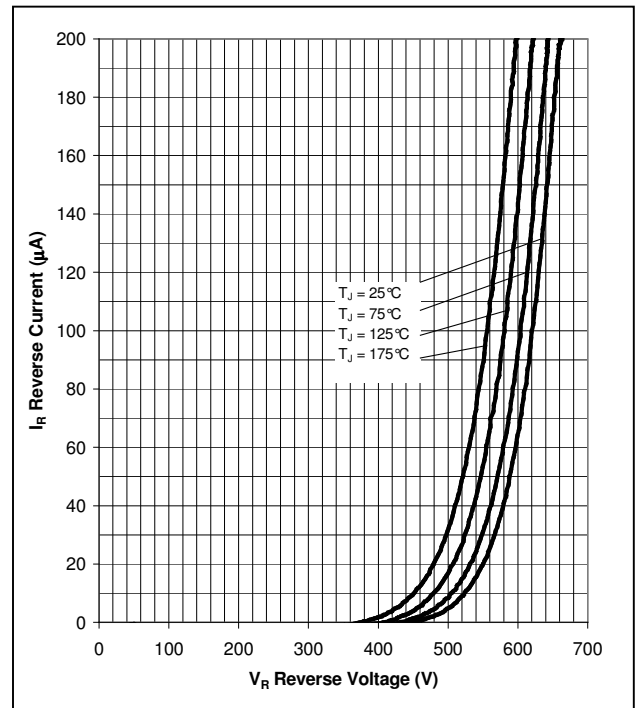


Figure 3. Current Derating

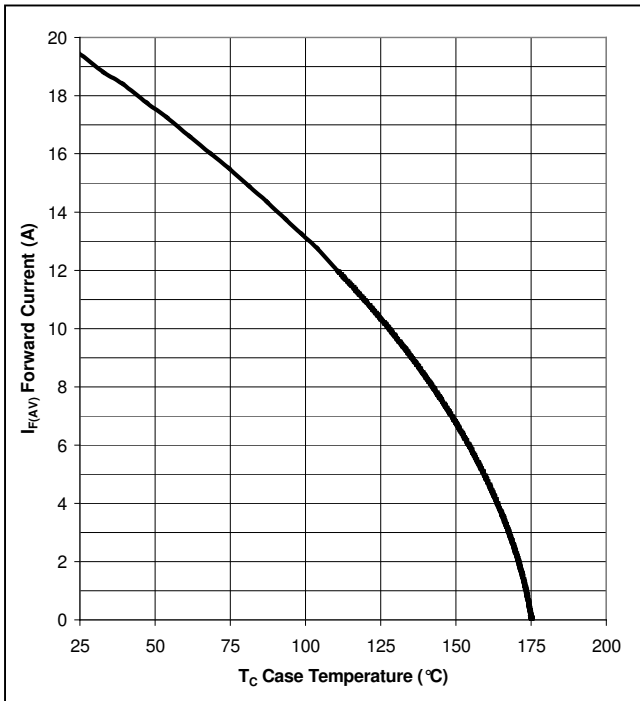


Figure 4. Capacitance vs. Reverse Voltage

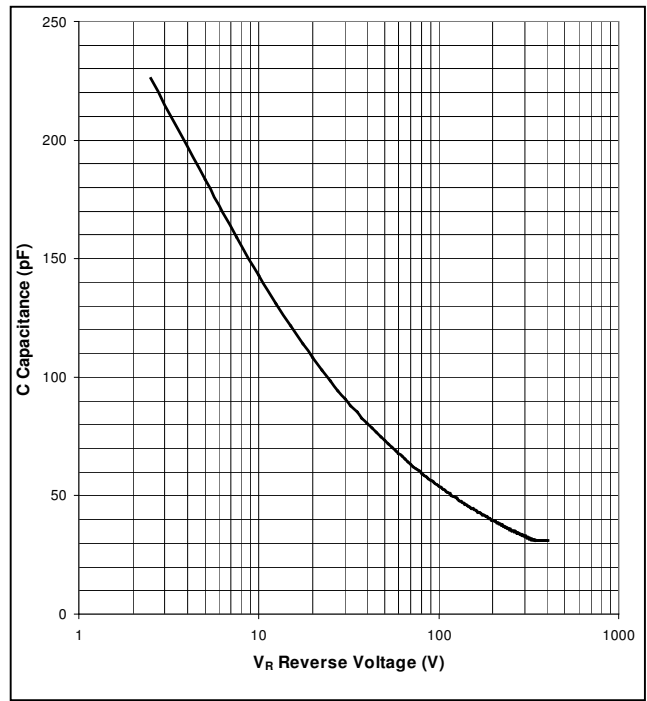
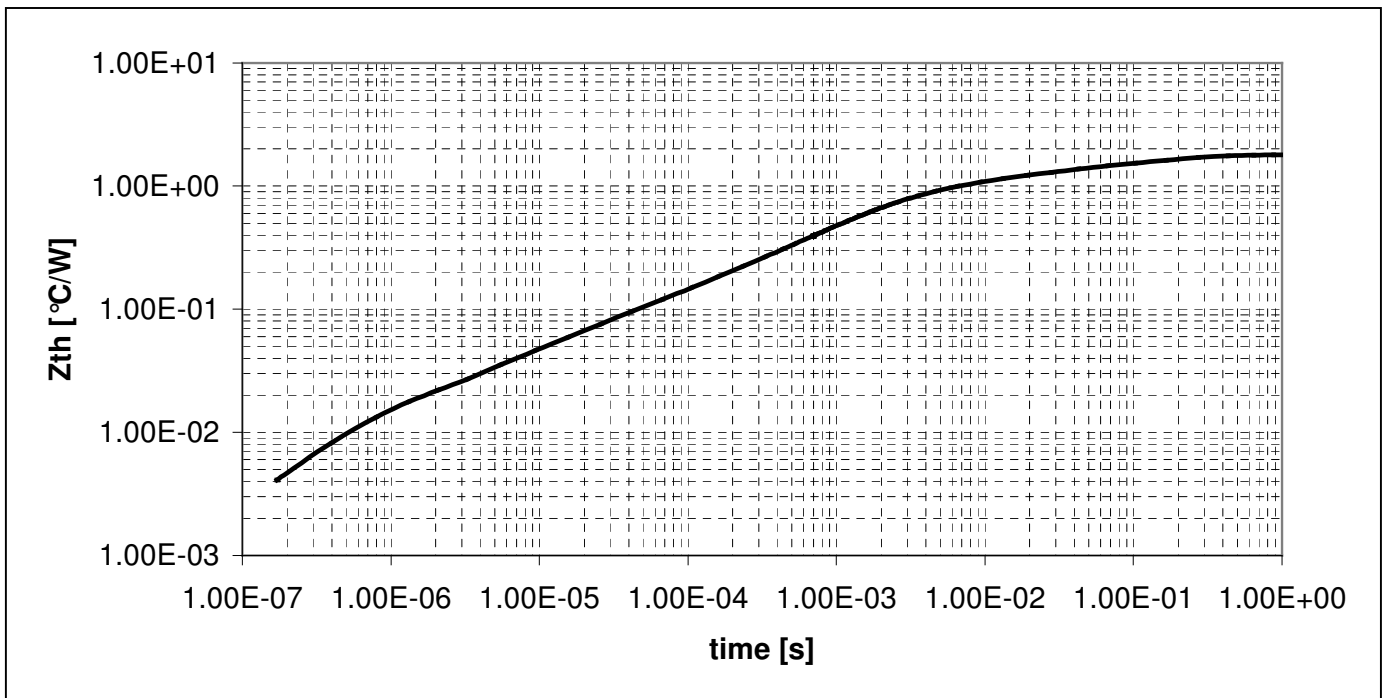
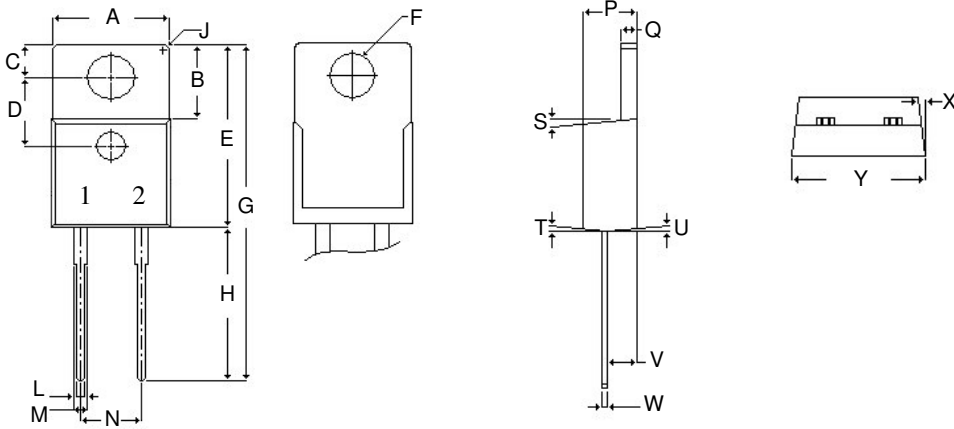


Figure 5. Transient Thermal Impedance



Package Dimensions

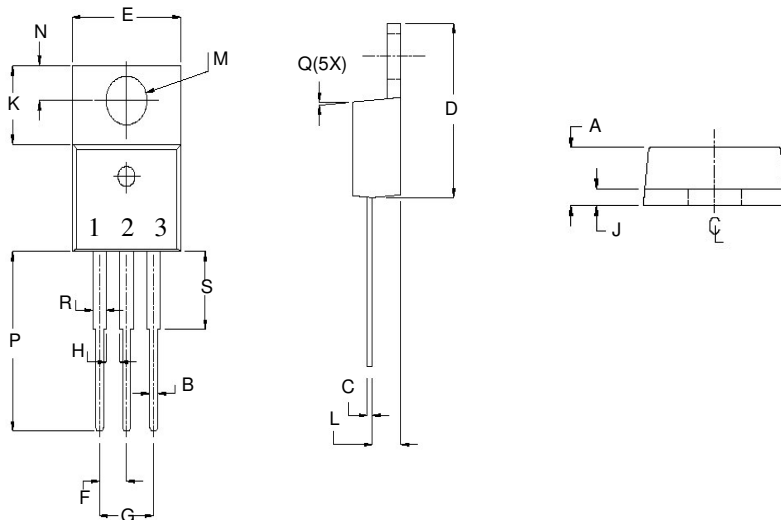
Package TO-220-2



POS	Inches		Millimeters	
	Min	Max	Min	Max
A	.381	.391	9.677	9.931
B	.240	.250	6.096	6.350
C	.100	.120	2.540	3.048
D	.223	.227	5.664	5.766
E	.595	.615	15.113	15.621
F	.143	.147	3.632	3.734
G	1.105	1.115	28.067	28.321
H	.500	.510	12.700	12.954
J	R 0.197		R 5.004	
L	.025	.035	.635	.889
M	.045	.055	1.143	1.397
N	.198	.202	5.029	5.131
P	.165	.185	4.191	4.699
Q	.048	.052	1.219	1.321
S	4°	6°	4°	6°
T	4°	6°	4°	6°
U	4°	6°	4°	6°
V	.094	.098	2.387	2.489
W	.018	.025	.458	.635
X	4.5°	5.5°	4.5°	5.5°
Y	.385	.405	9.779	10.287

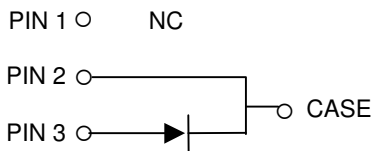


Package TO-220-3



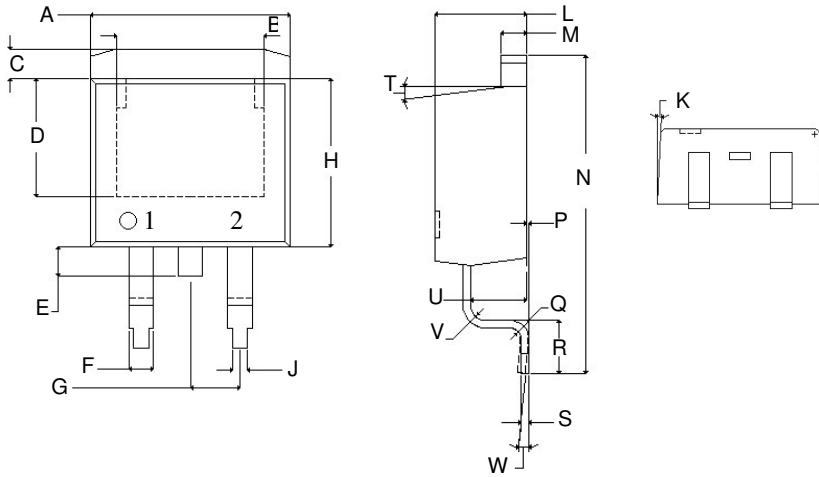
POS	Inches		Millimeters	
	Min	Max	Min	Max
A	.160	.190	4.06	4.83
B	.025	.040	0.63	1.02
C	.015	.022	0.38	0.56
D	.560	.590	14.22	14.99
E	.385	.415	9.78	10.54
F	.090	.110	2.29	2.79
G	.190	.210	4.83	5.33
H	.045	.055	1.14	1.40
J	.045	.055	1.14	1.40
K	.234	.258	5.94	6.55
L	.090	.115	2.29	2.92
M	.146	.156	3.71	3.96
N	.103	.113	2.62	2.87
P	.540	.560	13.72	14.22
Q	3°	7°	3°	7°
R	.045	.060	1.14	1.52
S	.243 REF		6.17 REF	

NOTE:
1. Dimension C apply for Solder Plate Finish.



Package Dimensions (Cont.)

Package TO-263-2

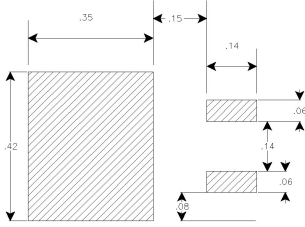


POS	Inches		Millimeters	
	Min	Max	Min	Max
A	.396	.406	10.058	10.312
B	.297	.303	7.544	7.696
C	.057	.063	1.448	1.600
D	.237	.243	6.015	6.167
E	.050	.070	1.270	1.778
F	.048	.052	1.219	1.321
G	.100TYP		2.540TYP	
H	.335	.345	8.509	8.763
J	.028	.032	.711	.813
K	2.0°	4.0°	2.0°	4.0°
L	.170	.180	4.318	4.572
M	.048	.052	1.219	1.321
N	.595	.615	15.113	15.621
P	0.00	.010	0.00	.254
Q	R0.018TYP	R0.022TYP	R0.457TYP	R0.559TYP
R	.090	.110	2.286	2.794
S	.013	.017	.330	.432
T	6.5°	8.5°	6.5°	8.5°
U	.103	.107	2.616	2.718
V	R0.028TYP	R0.032TYP	R0.711TYP	R0.813TYP
W	--	5.0°	--	5.0°

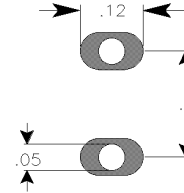


Part Number	Package	Marking
CSD06060A	TO-220-2	CSD06060
CSD06060B	TO-220-3	CSD06060
CSD06060G	TO-263-2	CSD06060

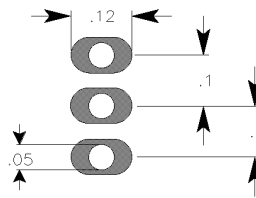
Recommended solder pad layout.



TO-263-2



TO-220-2



TO-220-3

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, air traffic control systems, or weapons systems.

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